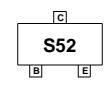


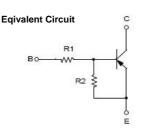
FJY4002R PNP Epitaxial Silicon Transistor

Features

- · Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor (R₁=10KΩ, R₂=10KΩ)
- Complement to FJY3002R







Absolute Maximum Ratings * T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	-50	V
V _{CEO}	Collector-Emitter Voltage	-50	V
V _{EBO}	Emitter-Base Voltage	-10	V
I _C	Collector Current	-100	mA
T _{STG}	Storage Temperature Range	-55~150	°C
TJ	Junction Temperature	150	°C
P _C	Collector Power Dissipation, by $R_{\theta JA}$	200	mW

These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

Thermal Characteristics* Ta=25°C unless otherwise noted

Symbol	Parameter	Мах	Units
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	600	°C/W

Minimum land pad size.

Electrical Characteristics* T_c = 25°C unless otherwise noted

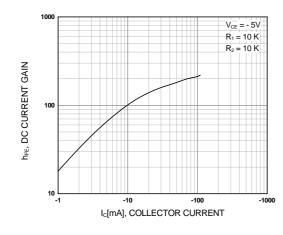
Parameter	Test Condition	MIN	Тур	MAX	Units
Collector-Emitter Breakdown Voltage	Ic = -10 uA, IE = 0	-50			V
RICEO Collector-Base Breakdown Voltage Ic = -100 uA, IB = 0		-50			V
ICBO Collector-Cutoff Current VCB = -40 V, IE				-0.1	uA
DC Current Gain	Vce = -5 V, Ic = -5mA	30			
Collector-Emitter Saturation Voltage	Ic = -10 mA, I _B = -0.5 mA			-0.3	V
Current Gain - Bandwidth Product	Vce = -10V, Ic = -5 mA		200		MHz
Output Capacitance	V _{CB} = -10 V, I _E = 0, f = 1.0 MHz		5.5		pF
Input Off Voltage	Vce = -5 V, Ic = -100uA	-0.5			V
Input On Voltage	Vce = -0.3V, Ic = -10mA			-3	V
Input Resistor		7	10	13	KΩ
Resistor Ratio		0.9	1.0	1.1	
	Collector-Emitter Breakdown Voltage Collector-Base Breakdown Voltage Collector-Cutoff Current DC Current Gain Collector-Emitter Saturation Voltage Current Gain - Bandwidth Product Output Capacitance Input Off Voltage Input On Voltage Input Resistor	Collector-Emitter Breakdown VoltageIc = -10 uA, IE = 0Collector-Base Breakdown VoltageIc = -100 uA, IE = 0Collector-Cutoff CurrentVcB = -40 V, IE = 0DC Current GainVcE = -5 V, Ic = -5mACollector-Emitter Saturation VoltageIc = -10 mA, IB = -0.5 mACurrent Gain - Bandwidth ProductVcE = -10V, Ic = -5 mAOutput CapacitanceVcB = -10 V, IE = 0, f = 1.0 MHzInput Off VoltageVcE = -5 V, Ic = -100uAInput On VoltageVcE = -0.3V, Ic = -10mAInput ResistorVcE = -0.3V, Ic = -10mA	Collector-Emitter Breakdown VoltageIc = -10 uA, IE = 0-50Collector-Base Breakdown VoltageIc = -10 uA, IB = 0-50Collector-Cutoff CurrentVcB = -40 V, IE = 0-50DC Current GainVcE = -5 V, Ic = -5mA30Collector-Emitter Saturation VoltageIc = -10 mA, IB = -0.5 mA30Current Gain - Bandwidth ProductVcE = -10 V, Ic = -5 mA0Output CapacitanceVcB = -10 V, Ic = -5 mA-0.5Input Off VoltageVcE = -5 V, Ic = -100uA-0.5Input On VoltageVcE = -0.3V, Ic = -10mA-0.5Input Resistor7-0.5	Collector-Emitter Breakdown VoltageIc = -10 uA, IE = 0-50Collector-Base Breakdown VoltageIc = -100 uA, IE = 0-50Collector-Cutoff CurrentVcB = -40 V, IE = 0-50DC Current GainVcE = -5 V, Ic = -5mA30Collector-Emitter Saturation VoltageIc = -10 mA, IB = -0.5 mA200Current Gain - Bandwidth ProductVcE = -10 V, Ic = -5 mA200Output CapacitanceVcB = -10 V, IE = 0, f = 1.0 MHz5.5Input Off VoltageVcE = -5 V, Ic = -100uA-0.5Input On VoltageVcE = -0.3V, Ic = -10mA7	Collector-Emitter Breakdown VoltageIc = -10 uA, IE = 0-50Collector-Base Breakdown VoltageIc = -100 uA, IB = 0-50Collector-Cutoff CurrentVcB = -40 V, IE = 0-0.1DC Current GainVcE = -5 V, Ic = -5mA30Collector-Emitter Saturation VoltageIc = -10 mA, IB = -0.5 mA-0.3Current Gain - Bandwidth ProductVcE = -10 V, Ic = -5 mA200Output CapacitanceVcB = -10 V, IE = 0, f = 1.0 MHz5.5Input Off VoltageVcE = -5 V, Ic = -100uA-0.5Input On VoltageVcE = -0.3V, Ic = -10mA-3Input Resistor71013

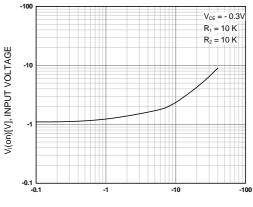
November 2006

Typical Performance Characteristics

Figure 1. DC current Gain

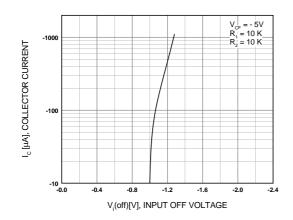




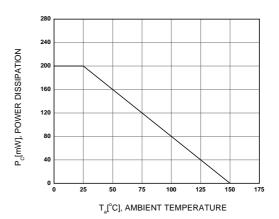


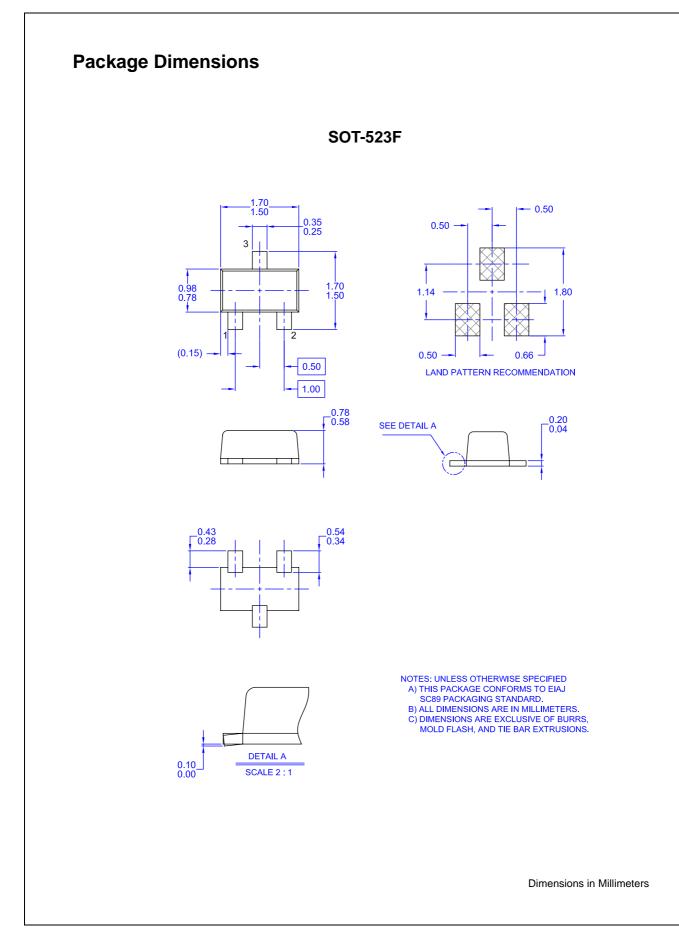
Ic[mA], COLLECTOR CURRENT

Figure 3. Input off Voltage











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	FAST®	MicroFET™	QS™	TinyBuck™	
	FASTr™	MicroPak™	QT Optoelectronics [™]	TinyPWM™	
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